

**1 550 nm FOR 156 Mb/s, 622 Mb/s  
InGaAsP MQW-DFB LASER DIODE****DESCRIPTION**

The NX6504 Series is a 1 550 nm Multiple Quantum Well (MQW) structured Distributed Feed-Back (DFB) laser diode with InGaAs monitor PIN-PD. This device is ideal for Synchronous Digital Hierarchy (SDH) system, STM-1, STM-4, ITU-T recommendations.

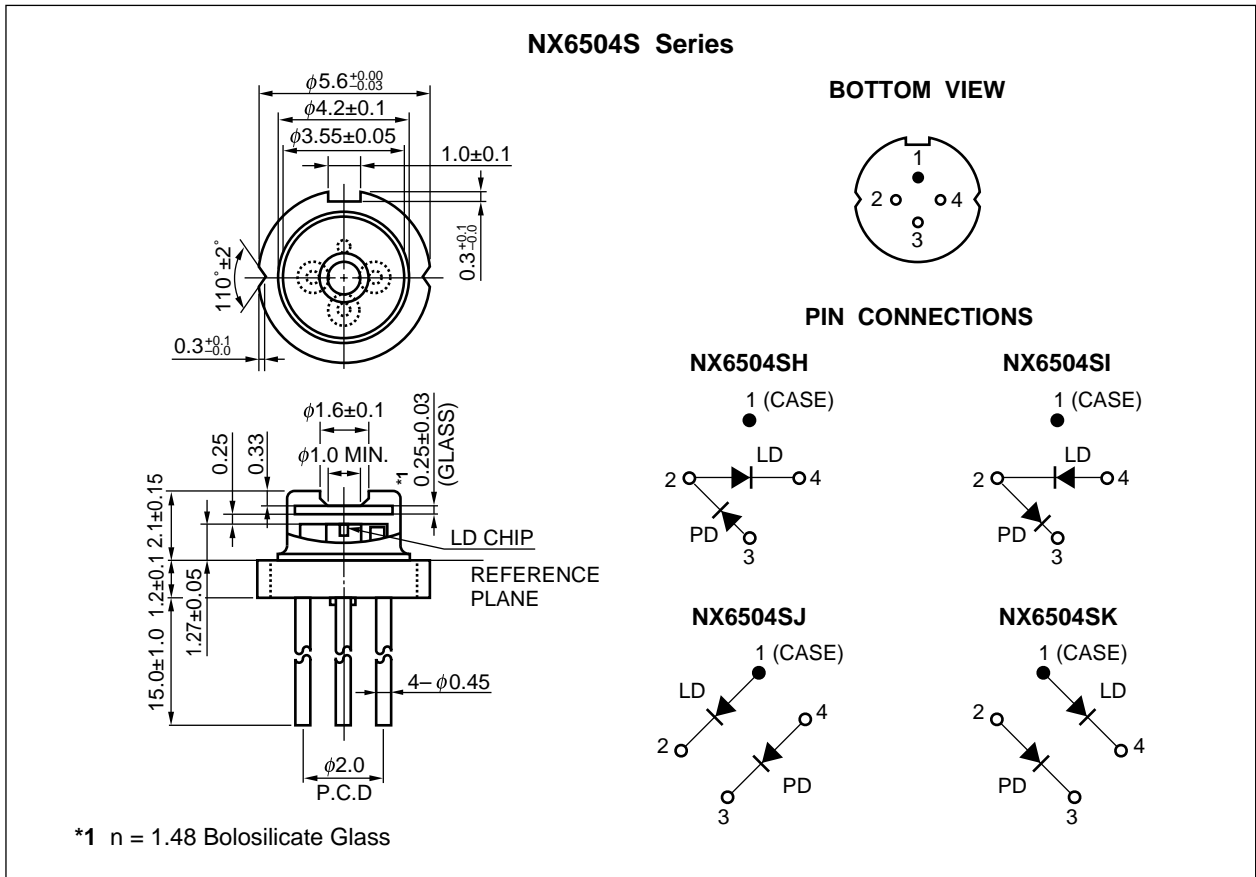
**FEATURES**

- Optical output power  $P_o = 5.0 \text{ mW}$
- Low threshold current  $I_{th} = 12 \text{ mA}$
- High speed  $t_r, t_f = 0.5 \text{ ns MAX.}$
- SMSR  $45 \text{ dB}$
- Wide operating temperature range  $T_c = -10 \text{ to } +85^\circ\text{C}$
- InGaAs monitor PIN-PD
- CAN package  $\phi 5.6 \text{ mm}$
- Based on Telcordia reliability

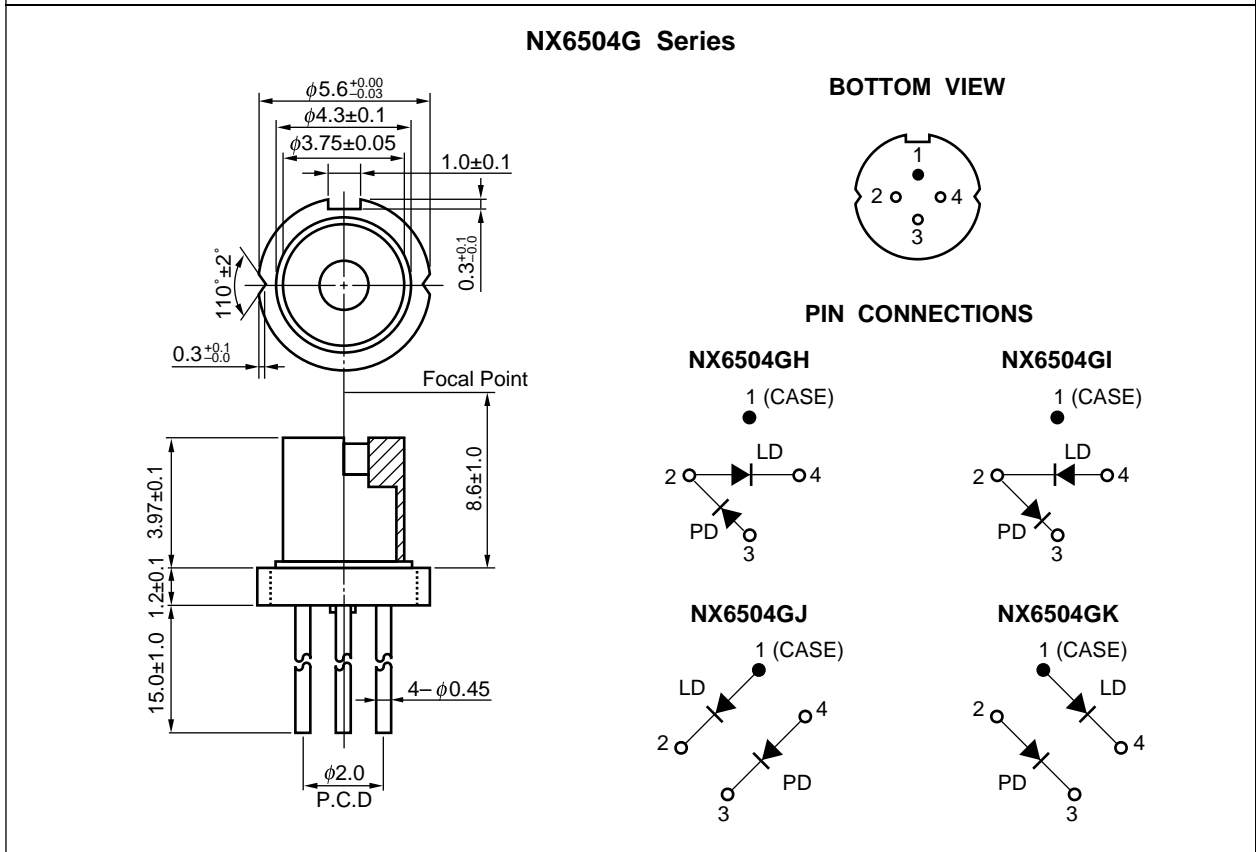
**NX6504S Series****NX6504G Series**

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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

PACKAGE DIMENSIONS (UNIT: mm)



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ORDERING INFORMATION

NX6504S Series

Part Number	Package	Pin Connections
NX6504SH	4-pin CAN with flat glass cap	
NX6504SI		
NX6504SJ		
NX6504SK		

NX6504G Series

Part Number	Package	Pin Connections
NX6504GH	4-pin CAN with aspherical lens cap	
NX6504GI		
NX6504GJ		
NX6504GK		

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Ratings	Unit
Optical Output Power	P <sub>o</sub>	10	mW
Forward Current of LD	I <sub>F</sub>	150	mA
Reverse Voltage of LD	V <sub>R</sub>	2.0	V
Forward Current of PD	I <sub>F</sub>	10	mA
Reverse Voltage of PD	V <sub>R</sub>	20	V
Operating Case Temperature	T <sub>C</sub>	-10 to +85	°C
Storage Temperature	T <sub>stg</sub>	-40 to +85	°C
Lead Soldering Temperature	T <sub>slid</sub>	350 (3 sec.)	°C
Relative Humidity (noncondensing)	RH	85	%

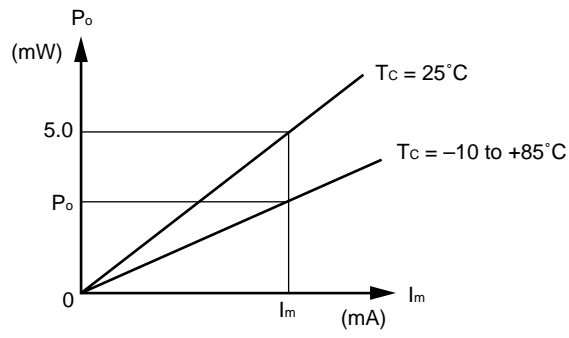
**ELECTRO-OPTICAL CHARACTERISTICS (T<sub>C</sub> = 25°C, unless otherwise specified)**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Operating Voltage	V <sub>op</sub>	P <sub>o</sub> = 5.0 mW, T <sub>C</sub> = -10 to +85°C		1.0	1.5	V
Threshold Current	I <sub>th</sub>			12	25	mA
		T <sub>C</sub> = 85°C		35	50	
Threshold Output Power	P <sub>th</sub>	T <sub>C</sub> = -10 to +85°C, I <sub>F</sub> = I <sub>th</sub>			200	μW
Differential Efficiency	η <sub>d</sub>		0.15	0.25		W/A
Temperature Dependence of Differential Efficiency	Δη <sub>d</sub>	$\Delta\eta_d = 10 \log \frac{\eta_d (@ 85^\circ\text{C})}{\eta_d (@ 25^\circ\text{C})}$	-3.0	-1.5		dB
Peak Emission Wavelength	λ <sub>p</sub>	P <sub>o</sub> = 5.0 mW, RMS (-20 dB) T <sub>C</sub> = -10 to +85°C	1 530		1 570	nm
Side Mode Suppression Ratio	SMSR	P <sub>o</sub> = 5.0 mW, T <sub>C</sub> = -10 to +85°C	30	45		dB
Vertical Beam Angle <sup>*1</sup>	θ <sub>L</sub>	P <sub>o</sub> = 5.0 mW, FAHM <sup>*2</sup>		30	40	deg.
Lateral Beam Angle <sup>*1</sup>	θ <sub>L</sub>	P <sub>o</sub> = 5.0 mW, FAHM <sup>*2</sup>		25	35	deg.
Rise Time	t <sub>r</sub>	10-90%		0.05	0.5	ns
Fall Time	t <sub>f</sub>	90-10%		0.2	0.5	ns
★ Monitor Current	I <sub>m</sub>	V <sub>R</sub> = 5 V, P <sub>o</sub> = 5.0 mW	200	600	1 000	μA
Monitor Dark Current	I <sub>D</sub>	V <sub>R</sub> = 5 V		0.1	10	nA
		V <sub>R</sub> = 5 V, T <sub>C</sub> = -10 to +85°C			500	
Monitor PD Terminal Capacitance	C <sub>t</sub>	V <sub>R</sub> = 5 V, f = 1 MHz		6	20	pF
Tracking Error <sup>*3</sup>	γ	I <sub>m</sub> = const. (@ P <sub>o</sub> = 5.0 mW, T <sub>C</sub> = 25°C) T <sub>C</sub> = -10 to +85°C	-1.0		1.0	dB

\*1 Applicable to only NX6504S Series

\*2 FAHM: Full Angle at Half Maximum

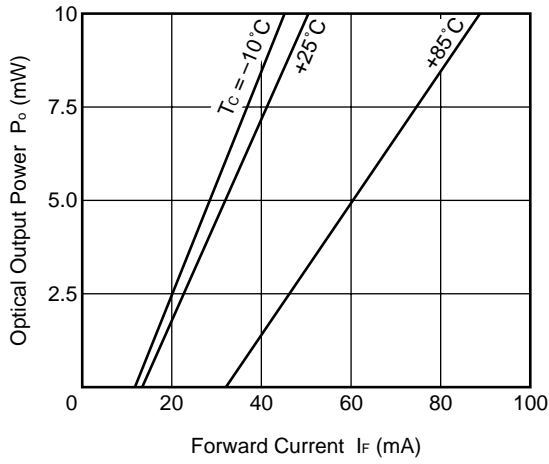
\*3 Tracking Error:  $\gamma$



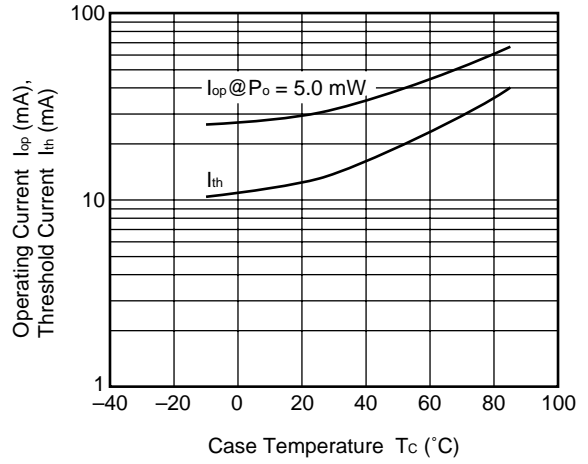
$$\gamma = \left| 10 \log \frac{P_o}{5.0} \right| \text{ [dB]}$$

★ TYPICAL CHARACTERISTICS ( $T_c = -10$  to  $+85^\circ\text{C}$ )

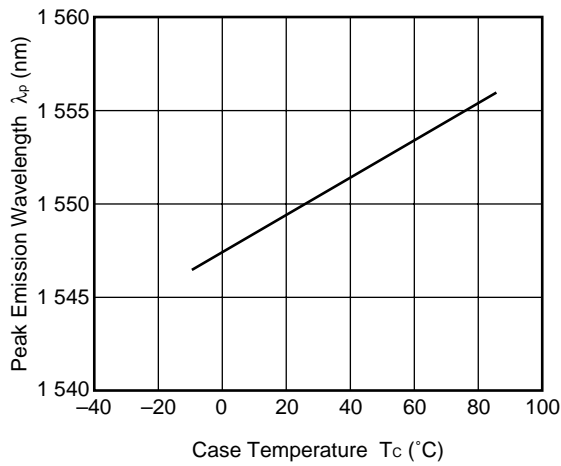
OPTICAL OUTPUT POWER vs. FORWARD CURRENT



OPERATING CURRENT AND THRESHOLD CURRENT vs. CASE TEMPERATURE

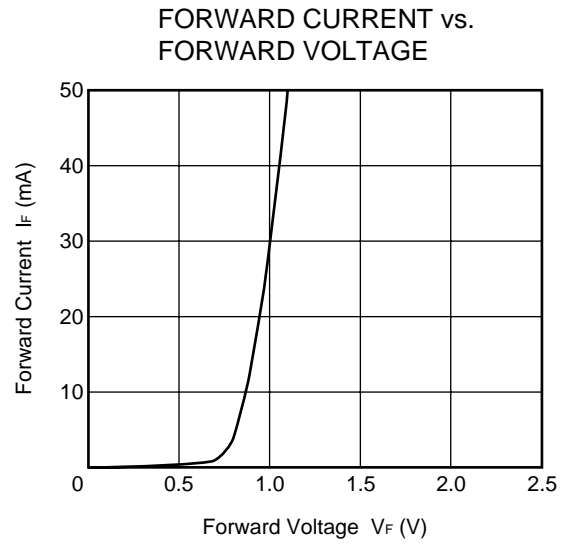
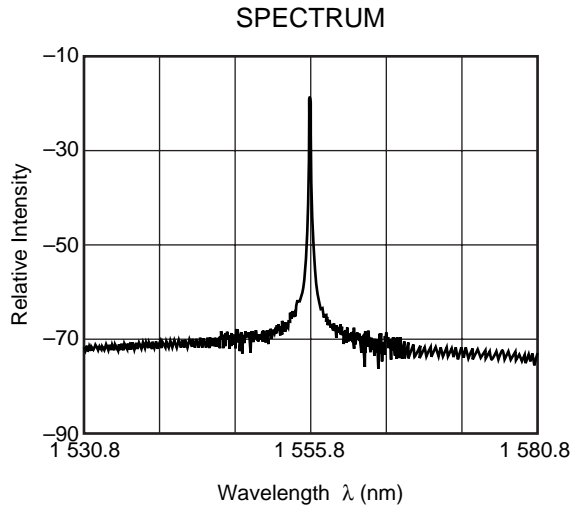
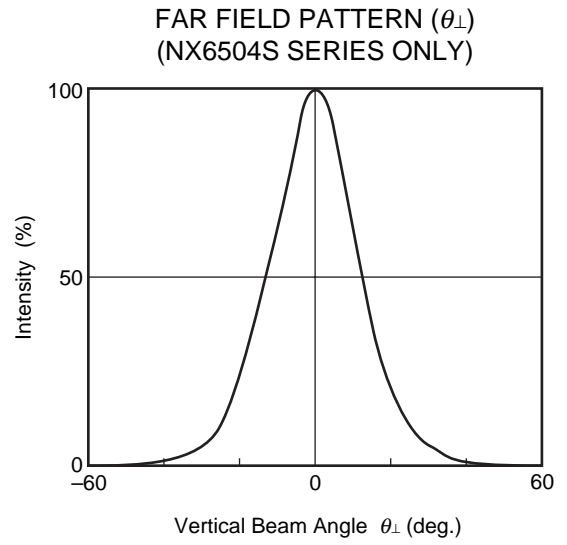
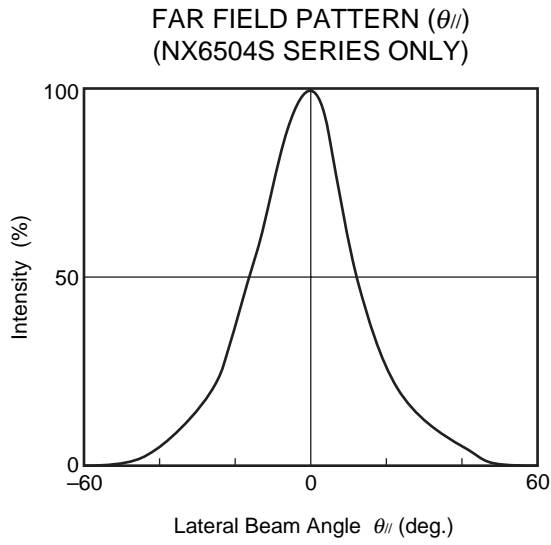


TEMPERATURE DEPENDENCE OF PEAK EMISSION WAVELENGTH



**Remark** The graphs indicate nominal characteristics.

★ TYPICAL CHARACTERISTICS (T<sub>c</sub> = 25°C)



**Remark** The graphs indicate nominal characteristics.

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Part Number	Absolute Maximum Ratings		Electro-Optical Characteristics				Application	Package
			@T <sub>c</sub> = 25°C	@T <sub>c</sub>				
	T <sub>c</sub> (°C)	T <sub>stg</sub> (°C)	I <sub>th</sub> (mA)	P <sub>o</sub> (mW)	λ (nm)			
			TYP.	TYP.	MIN.	MAX.		
NX5302 Series	-40 to +85	-40 to +85	10	5	1 263	1 360	156 Mb/s: STM-1 (I-1, S-1.1, L-1.1)	CAN
							622 Mb/s: STM-4 (I-4, S-4.1)	
★ NX5306 Series	-40 to +85	-40 to +85	10	5	1 263	1 360	156 Mb/s: STM-1 (I-1, S-1.1, L-1.1)	CAN
							622 Mb/s: STM-4 (I-4, S-4.1)	
★ NX5307 Series	-40 to +85	-40 to +85	10	10	1 266	1 360	2.5 Gb/s: STM-16	CAN
NX6301 Series	-40 to +85	-40 to +85	13	5	1 280	1 335	156 Mb/s: STM-1	CAN
							622 Mb/s: STM-4	
NX6504 Series	-10 to +85	-40 to +85	12	5	1 530	1 570	156 Mb/s: STM-1	CAN
							622 Mb/s: STM-4	

**REFERENCE**

Document Name	Document No.
OPTICAL SEMICONDUCTOR DEVICES FOR FIBEROPTIC COMMUNICATIONS SELECTION GUIDE	PX10161E
Opto-Electronics Devices Pamphlet	PX10160E
NEC semiconductor device reliability/quality control system <sup>*1</sup>	C11159E
Quality grades on NEC semiconductor devices <sup>*1</sup>	C11531E
SEMICONDUCTOR SELECTION GUIDE –Products and Packages– <sup>*1</sup>	X13769E

\*1 Published by NEC Corporation

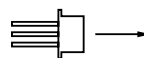
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**SAFETY INFORMATION ON THIS PRODUCT**



**SEMICONDUCTOR LASER**



**AVOID EXPOSURE-Invisible Laser Radiation is emitted from this aperture**

<p><b>Warning</b> Laser Beam</p>	<p>A laser beam is emitted from this diode during operation. The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight.</p> <ul style="list-style-type: none"> <li>• Do not look directly into the laser beam.</li> <li>• Avoid exposure to the laser beam, any reflected or collimated beam.</li> </ul>
<p><b>Caution</b> GaAs Products</p>	<p>The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested.</p> <ul style="list-style-type: none"> <li>• Do not destroy or burn the product.</li> <li>• Do not cut or cleave off any part of the product.</li> <li>• Do not crush or chemically dissolve the product.</li> <li>• Do not put the product in the mouth.</li> </ul> <p>Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.</p>

► **Business issue**

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► **Technical issue**

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